NT OR PW PACKAGE

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- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 15 ns at 5 V
- **Schmitt-Trigger Inputs Allow for Slow Input** Rise/Fall Time
- Polarity Control for Y Outputs Selects True or Complementary Logic
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) $>2.3 \text{ V at V}_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Ioff Supports Partial-Power-Down Mode Operation
- **Supports Mixed-Mode Voltage Operation on All Ports**
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

(TOP VIEW) 24 🛮 V_{CC} T/C 23 P Α [] В 🛮 3 22 N 21 Y1 D1 | 4 20 TY2 D2 | 5 рз Г 6 19 **∏** Y3 D4 [] 7 18 **∏** Y4 17 Y5 D5 🛮 8 D6 [] 9 16 Y6 D7 ∏ 10 15 ∏ Y7 14 Y8 D8 [] 11 13 OE **GND** | 12

description/ordering information

The SN74LV8151 is a 10-bit universal Schmitt-trigger buffer with 3-state outputs, designed for 2-V to 5.5-V $m V_{CC}$ operation. The logic control ($\overline{\Gamma/C}$) pin allows the user to configure Y1 to Y8 as noninverting or inverting outputs. When T/\overline{C} is high, the Y outputs are noninverted (true logic), and when T/\overline{C} is low, the Y outputs are inverted (complementary logic).

When output-enable (OE) input is low, the device passes data from Dn to Yn. When OE is high, the Y outputs are in the high-impedance state. The path A to P is a simple Schmitt-trigger buffer, and the path B to N is a simple Schmitt-trigger inverter.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down, OE should be tied to VCC through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

TA	PACKAGE [†]		PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – NT	Tube	SN74LV8151NT	SN74LV8151NT		
-40°C to 85°C	TOOOD DW	Tube	SN74LV8151PW	11/0454		
	TSSOP – PW	Tape and reel	SN74LV8151PWR	LV8151		

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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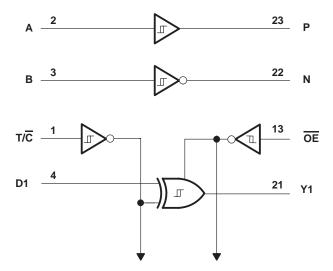
FUNCTION TABLES

INPUT A	OUTPUT P
L	L
Н	Н

INPUT B	OUTPUT N
L	Н
Н	L

	INPUTS		OUTPUT
OE	T/C	D	Υ
L	L	L	Н
L	L	Н	L
L	Н	L	L
L	Н	Н	Н
Н	Χ	X	Z

logic diagram



To Seven Other Channels

SN74LV8151 10-BIT UNIVERSAL SCHMITT-TRIGGER BUFFER WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high-impedance	
or power-off state, V _O (see Note 1)	
Output voltage range, VO (see Notes 1 and 2)	\dots -0.5 V to V _{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±35 mA
Continuous current through V _{CC} or GND	±70 mA
Package thermal impedance, θ _{JA} (see Note 3): NT package	67°C/W
(see Note 4): PW package	88°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 5.5 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51-3.
- 4. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 5)

			VCC	MIN	MAX	UNIT
VCC	Supply voltage			2	5.5	V
			2 V	1.5		
V	High level innerticate as		2.3 V to 2.7 V	V _{CC} ×0.7		V
۷IH	High-level input voltage Low-level input voltage Input voltage Output voltage High or low state 3-state High-level output current	3 V to 3.6 V	V _{CC} ×0.7		V	
			4.5 V to 5.5 V	V _{CC} ×0.7	2 5.5 1.5 CC × 0.7 CC × 0.7	
			2 V		0.5	
.,	. Low lovel input valtage		2.3 V to 2.7 V		$V_{CC} \times 0.3$.,
V_{IL}	High-level input voltage Low-level input voltage Input voltage Output voltage High or low state 3-state High-level output current Low-level output current	3 V to 3.6 V		$V_{CC} \times 0.3$	V	
		gh-level input voltage put voltage utput voltage High or low state 3-state gh-level output current pw-level output current T/C, OE inputs A, B, D inputs	4.5 V to 5.5 V		$V_{CC} \times 0.3$	
٧ _I	Input voltage			0	5.5	V
	• • • •	High or low state		0	VCC	.,
VO	Output voltage	3-state		0	0 5.5 -50	V
			2 V		-50	μΑ
	DH High-level output current		2.3 V to 2.7 V		-2	
ЮН			3 V to 3.6 V		-6	mA
		4.5 V to 5.5 V		-12		
			2 V		50	μΑ
			2.3 V to 2.7 V		2	
IOL	Low-level output current		3 V to 3.6 V		6	mA
			4.5 V to 5.5 V		12	
			2.3 V to 2.7 V		200	
		T/C, OE inputs	3 V to 3.6 V		100	ns/V
			4.5 V to 5.5 V		20	
Δt/Δv	Input transition rise or fall rate		2.3 V to 2.7 V		4	
		A, B, D inputs	3 V to 3.6 V		3	ms/V
			4.5 V to 5.5 V		2	
TA	Operating free-air temperature	•		-40	85	°C

NOTES: 5. All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	v _{cc}	MIN	TYP	MAX	UNIT	
V _{T+}		2.5 V			1.75		
Positive-going input	A, B, and D inputs	3.3 V			2.31	V	
threshold voltage		5 V			3.5		
V _T _		2.5 V	0.75				
Negative-going input	A, B, and D inputs	3.3 V	0.99			V	
threshold voltage		5 V	1.5				
ΔVΤ		2.5 V	0.25		1		
Hysteresis	A, B, and D inputs	3.3 V	0.33		1.32	V	
$(V_{T+} - V_{T-})$		5 V	0.5		2		
	I _{OH} = -50 μA	2 V to 5.5 V	V _{CC} - 0.1				
	$I_{OH} = -2 \text{ mA}$	2.3 V	2			.,	
VOH	$I_{OH} = -6 \text{ mA}$	3 V	2.48			V	
	I _{OH} = -12 mA	4.5 V	3.8				
	I _{OL} = 50 μA	2 V to 5.5 V			0.1		
	I _{OL} = 2 mA	2.3 V			0.4	.,	
VOL	I _{OL} = 6 mA	3 V			0.44	V	
	I _{OL} = 12 mA	4.5 V			0.55		
II	V _I = 5.5 V or GND	0 to 5.5 V			±1	μΑ	
loz	$V_O = V_{CC}$ or GND	5.5 V			±5	μΑ	
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			20	μΑ	
l _{off}	V _I or V _O = 0 to 5.5 V	0			5	μΑ	
	V V OND	3.3 V		3			
Ci	$V_I = V_{CC}$ or GND	5 V		3		pF	
	V V STONID	3.3 V		5			
Co	$V_O = V_{CC}$ or GND	5 V		5		pF	

switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T _A = 25°C	MIN	MAX	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	TYP	IVIIIN	IVIAA	UNIT	
	A or B	P or N		22	1	45		
t _{pd}	D	V	C _L = 15 pF]	23	1	49	ns
·	T/C	Υ		24	1	50		
t _{en}	ŌĒ	Υ] - '	12	1	25	ns	
t _{dis}	ŌE	Υ		11	1	20	ns	
	A or B	A or B P or N		26	1	52		
tpd	D	V]	28	1	57	ns	
	T/C	Y	$C_{L} = 50 \text{ pF}$	29	1	58		
t _{en}	ŌE	Υ	- OL = 30 βi	15	1	30	ns	
^t dis	ŌĒ	Υ		15	1	26	ns	



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switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM TO	то	LOAD CAPACITA	T _A = 25°C		BAAY			
PARAMETER	(INPUT)	(OUTPUT)	NCE	TYP	MIN	MAX	UNIT		
	A or B	P or N		14	1	26			
^t pd	D	V	C _L = 15 pF			15	1	29	ns
	T/C	Υ		16	1	30			
t _{en}	ŌĒ	Υ		9	1	16	ns		
t _{dis}	ŌĒ	Υ		8	1	14	ns		
	A or B	P or N		17	1	32			
^t pd	D	Y		18	1	34	ns		
	T/C		C _L = 50 pF	20	1	36			
t _{en}	ŌE	Υ		11	1	20	ns		
^t dis	ŌĒ	Υ]	11	1	18	ns		

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

242445	FROM	то	LOAD	T _A = 25°C						
PARAMETER	(INPUT)	(OUTPUT)	CAPACITA NCE	TYP	MIN	MAX	UNIT			
	A or B	P or N		9	1	15				
^t pd	D	V	C _L = 15 pF	ĺ	ĺ	[10	1	16	ns
	T/C	Υ		11	1	17				
t _{en}	ŌĒ	Υ		6	1	10.5	ns			
^t dis	ŌE	Υ		6	1	10	ns			
	A or B	P or N		11	1	18				
^t pd	D			12	1	20	ns			
фа	T/C	Υ	$C_L = 50 \text{ pF}$	13	1	21				
t _{en}	ŌĒ	Υ		8	1	12.5	ns			
^t dis	ŌĒ	Υ		8	1	11.5	ns			

noise characteristics, $V_{CC} = 3.3 \text{ V}$, $C_L = 50 \text{ pF}$ (see Note 6)

	DADAMETED	T _A = 25°C			
	PARAMETER		TYP	MAX	UNIT
VOL(P)	Quiet output, maximum dynamic V _{OL}		0.6		V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.6		V
V _{OH(V)}	Quiet output, minimum dynamic VOH		2.9		V
VIH(D)	High-level dynamic input voltage	2.31			V
V _{IL(D)}	Low-level dynamic input voltage			0.99	V

NOTE 6: Characteristics are for surface-mount packages only.

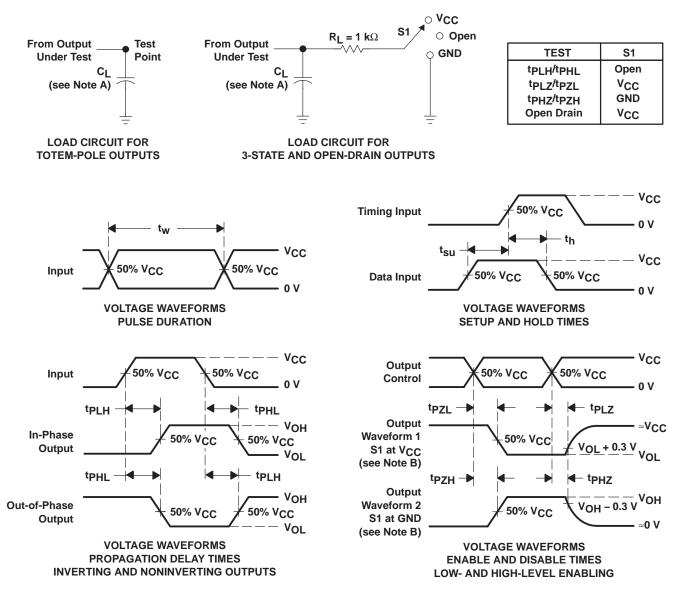


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operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	VCC	TYP	UNIT
C . Power dissination consistence	Cı = No load. f = 1 MHz	3.3 V	15	PΓ	
Cpd	Power dissipation capacitance	$C_L = No load, f = 1 MHz$	5 V	16	рг

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq 3$ ns, $t_f \leq 3$ ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpHL and tpLH are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms









PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LV8151DGVR	ACTIVE	TVSOP	DGV	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV8151DGVRE4	ACTIVE	TVSOP	DGV	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV8151DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV8151DWE4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV8151DWR	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV8151DWRE4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV8151NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU SN	Level-NA-NA-NA
SN74LV8151NTE4	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU SN	Level-NA-NA-NA
SN74LV8151PW	ACTIVE	TSSOP	PW	24	60	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV8151PWE4	ACTIVE	TSSOP	PW	24	60	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV8151PWR	ACTIVE	TSSOP	PW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

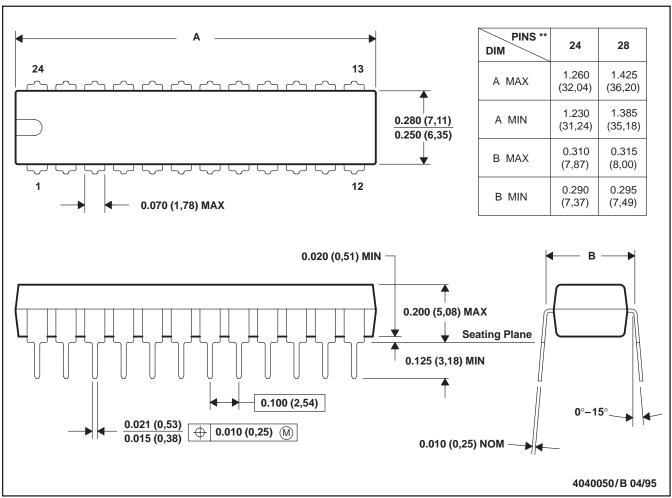
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NT (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

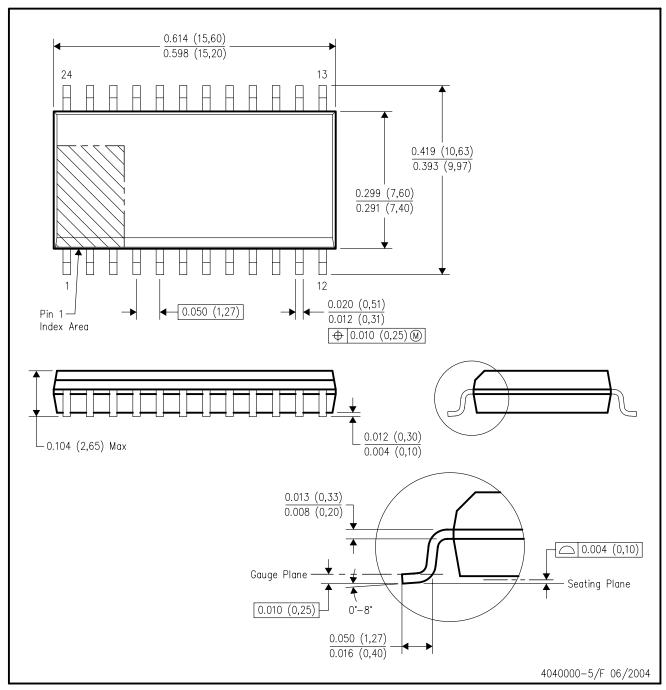
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



DW (R-PDSO-G24)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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